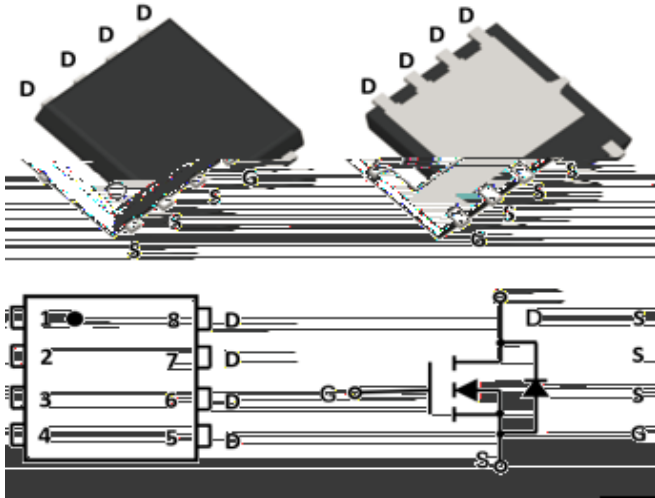




# YJG120G10BR

## N-Channel Enhancement Mode Field Effect Transistor

### PDFN5060



### Product Summary

$V_{DS}$	100V
$I_D$	120A
$R_{DS(ON)}$ (at $V_{GS}=10V$ )	4.2mohm
100% UIS Tested	
100% $V_{DS}$ Tested	

### General Description

Split gate trench MOSFET technology  
 Excellent package for heat dissipation  
 High density cell design for low  $R_{DS(ON)}$

### Applications

Power switching application  
 Uninterruptible power supply  
 PD charge  
 DC-DC convertor

### Absolute Maximum Ratings ( $T_A=25$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		$V_{DS}$	100	V
Gate-source Voltage		$V_{GS}$	$\pm 20$	V
Drain Current	$T_C=25$	$I_D$	120	A
	$T_C=100$		76	
Pulsed Drain Current <sup>A</sup>		$I_{DM}$	480	A
Avalanche energy <sup>B</sup>		EAS	552	mJ
Total Power Dissipation <sup>C</sup>	$T_C=25$	$P_D$	108	W
	$T_C=100$		43	
Junction and Storage Temperature Range		$T_J, T_{STG}$	-55 +150	

### Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient <sup>D</sup>	Steady-State	R	45	55	/W
Thermal Resistance Junction-to-Case	Steady-State	R	0.95	1.16	

### Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJG120G10BR	F1	G120G10BR	5000	10000	100000	13 reel



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## Electrical Characteristics (T<sub>J</sub>=25 unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> =250	100	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V	-	-	1	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = 20V, V <sub>DS</sub> =0V	-	-	100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =250	2	2.8	4	V
Static Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =60A	-	3.5	4.2	m
		V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	3.5	4.2	m
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =60A, V <sub>GS</sub> =0V	-	0.9	1.2	V
Gate resistance	R <sub>G</sub>	f=1MHz, Open drain	-	0.8	-	
Maximum Body-Diode Continuous Current	I <sub>S</sub>		-	-	120	A
<b>Dynamic Parameters</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =50V, V <sub>GS</sub> =0V, f=1MHZ	-	4400		pF
Output Capacitance	C <sub>oss</sub>		-	1600		
Reverse Transfer Capacitance	C <sub>rss</sub>		-	20		
<b>Switching Parameters</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =50V, I <sub>D</sub> =60A	-	39	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	14	-	
Gate-Drain Charge	Q <sub>gd</sub>		-	6	-	
Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> =60A, di/dt=500A/us	-	180	-	nC
Reverse Recovery Time	t <sub>rr</sub>		-	40	-	nS
Turn-on Delay Time	t <sub>D(on)</sub>	V <sub>GS</sub> =10V, V <sub>DD</sub> =50V, I <sub>D</sub> =60A R <sub>GEN</sub> =2.2	-	20	-	nS
Turn-on Rise Time	t <sub>r</sub>		-	95	-	
Turn-off Delay Time	t <sub>D(off)</sub>		-	30	-	
Turn-off fall Time	t <sub>f</sub>		-	7	-	

A. Repetitive rating; pulse width limited by max. junction temperature.

B. T<sub>J</sub>=25 , V<sub>DD</sub>=50V, V<sub>G</sub>=10V, R<sub>G</sub> 2mH, I<sub>AS</sub>=23.5A.

C. P<sub>d</sub> is based on max. junction temperature, using junction-case thermal resistance.

D. The value of R is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub> =25 . The maximum allowed junction temperature of 150 . The value in any given application depends on the user's specific board design.





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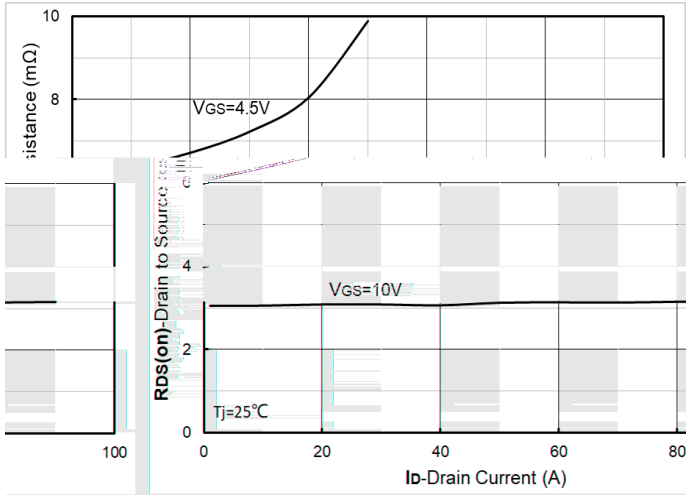


Figure7. RDson VS Drain Current

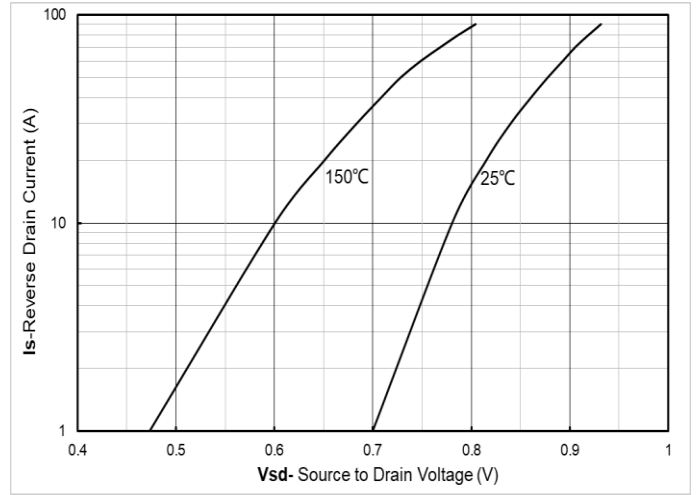


Figure8. Forward characteristics of reverse diode

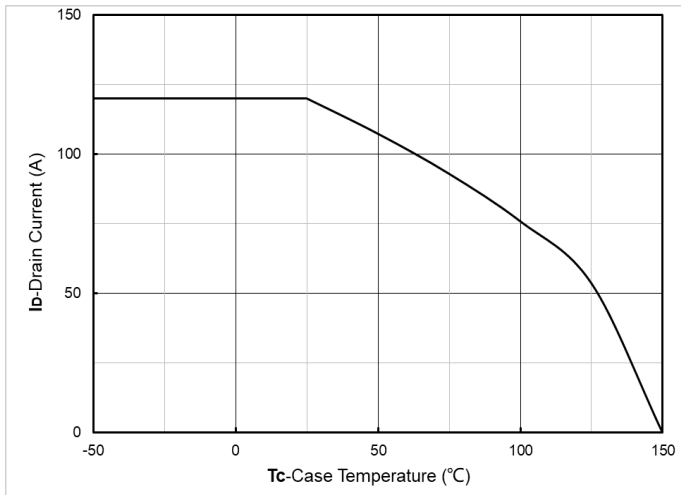


Figure9. Current dissipation

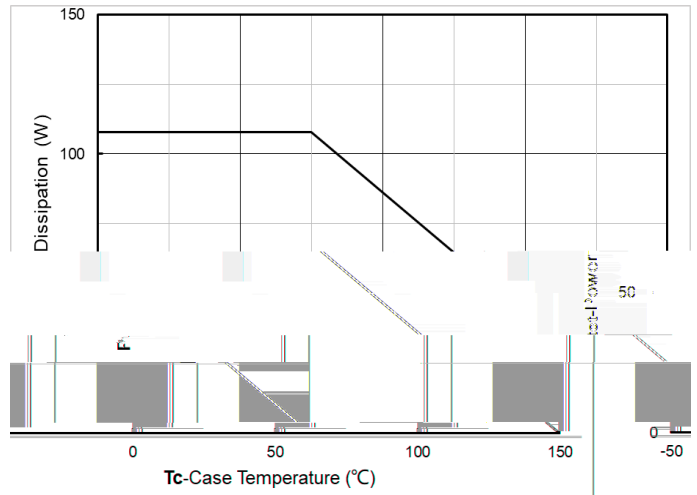


Figure10. Power dissipation

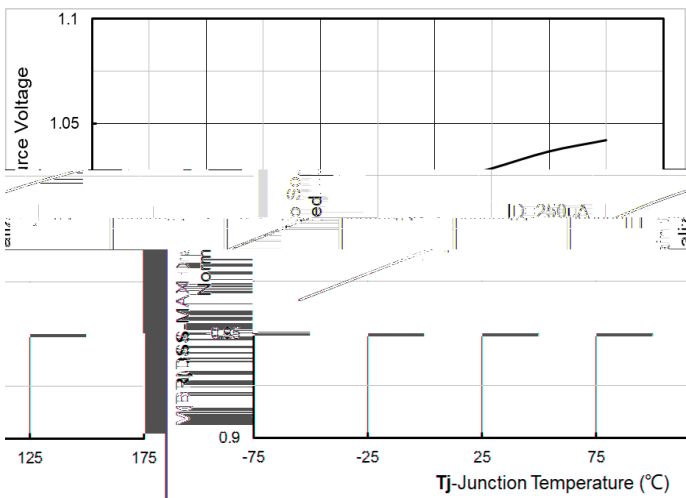


Figure11. Normalized breakdown voltage

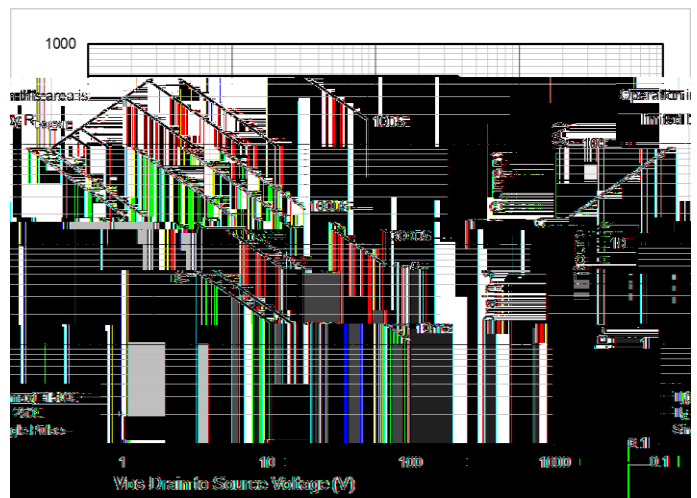


Figure12. Safe Operation Area

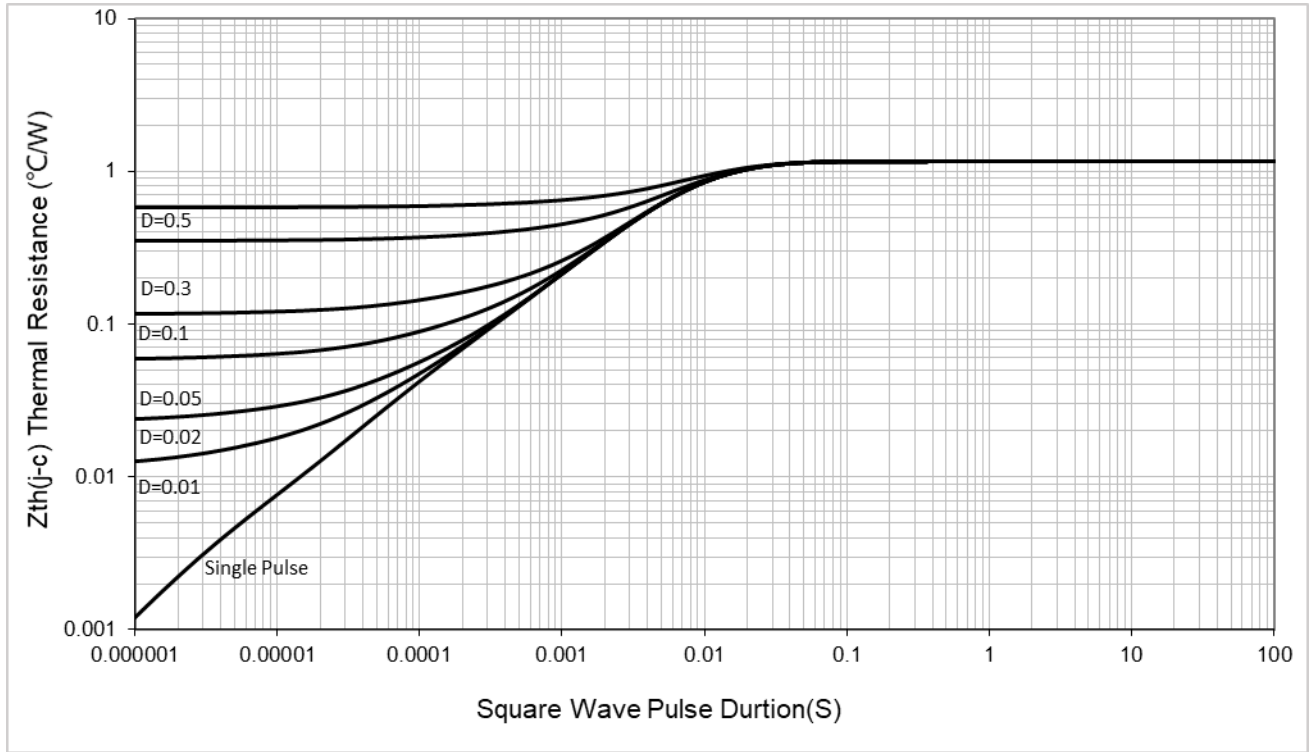
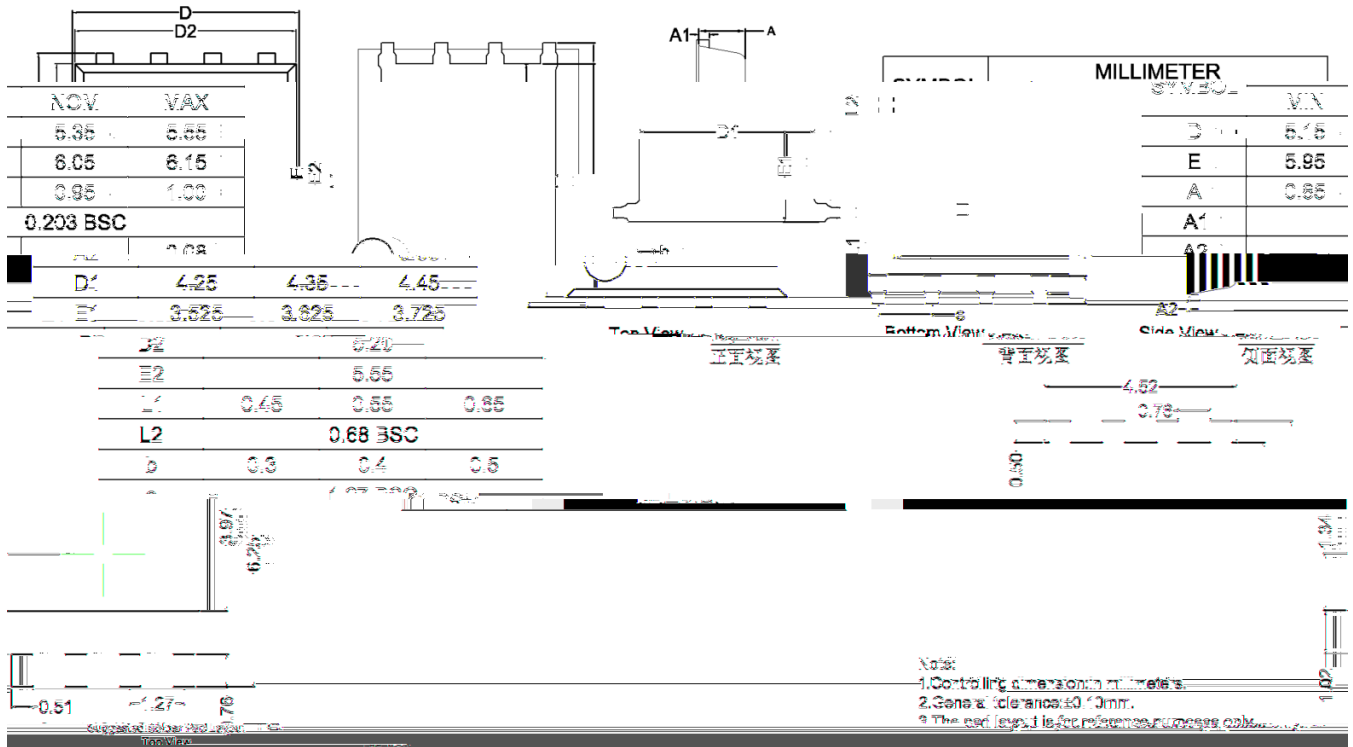


Figure13. Maximum Transient Thermal Impedan



# YJG120G10BR

## PDFN5060-8L-D-0.95MM Package information





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